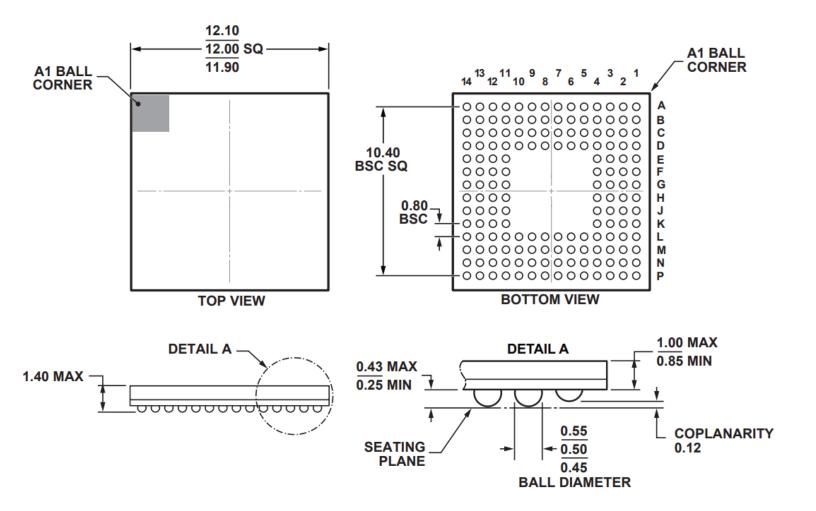
CPU-AGB-E Datasheet

By HDR

160-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-160-1)
Dimensions shown in millimeters



	1	2	3	4	5	6	7	8	9	10	11	12	13	14
Α	NC	cs	A 1	А3	A 5	A 7	А9	A11	A13	A15	D1	D3	D5	NC
В	RD	Α0	A2	A4	A6	A8	A10	A12	A14	D0	D2	D4	D6	D7
С	PHI	WR	NC	NC	GND	3.3V	GND	3.3V	GND	GND	3.3V	GND	RESET	IRQ
D	sc	SD	NC	GND	3.3V	GND	3.3V	GND	3.3V	1.8V	GND	CN	Audio_Right	Audio_Left
E	SI	so	NC	3.3V							3.3V	NC	SW_A	sw_B
F	NC	NC	NC	GND				GND	CN	SW_SELECT	sw_r			
G	NC	NC	NC	1.8V	Game Boy Micro CPU Pinout By HDR						GND	3.3V	SW_RIGHT	SW_START
н	NC	NC	NC	GND	Came Boy Micro Or o Fillout By HDR							GND	SW_LEFT	SW_DOWN
J	NC	NC	NC	GND				3.3V	GND	sw_L	SW_UP			
к	NC	NC	NC	3.3V								3.3V	GND	NC
L	NC	NC	NC	GND	1.8V	GND	1.8V	3.3V	GND	3.3V	GND	REV	GND	XTAL
М	NC	NC	NC	3.3V	GND	NC	GND	PS	LDR3	LDG5	LDG2	CLS	SPS	MOD
N	NC	NC	NC	NC	NC	NC	DCK	LDR5	LDR2	LDG4	LDG1	LDB4	LDB2	SPL
Р	NC	NC	NC	NC	NC	NC	LP	LDR4	LDR1	LDG3	LDB5	LDB3	LDB1	NC